

Abstract Submitted
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Oxidation of atomically thin MoS₂ on SiO₂ MAHITO YAMAMOTO, WILLIAM CULLEN, THEODORE EINSTEIN, MICHAEL FUHRER, Materials Research Science and Engineering Center, University of Maryland, College Park, MD 20742-4111 — Surface oxidation of MoS₂ markedly affects its electronic, optical, and tribological properties. However, oxidative reactivity of atomically thin MoS₂ has yet to be addressed. Here, we investigate oxidation of atomic layers of MoS₂ using atomic force microscopy and Raman spectroscopy. MoS₂ is mechanically exfoliated onto SiO₂ and oxidized in Ar/O₂ or Ar/O₃ (ozone) at 100-450 °C. MoS₂ is much more reactive to O₂ than an analogous atomic membrane of graphene and monolayer MoS₂ is completely etched very rapidly upon O₂ treatment above 300 °C. Thicker MoS₂ (> 15 nm) transforms into MoO₃ after oxidation at 400 °C, which is confirmed by a Raman peak at 820 cm⁻¹. However, few-layer MoS₂ oxidized below 400 °C exhibits no MoO₃ Raman mode but etch pits are formed, similar to graphene. We find atomic layers of MoS₂ shows larger reactivity to O₃ than to O₂ and monolayer MoS₂ transforms chemically upon O₃ treatment even below 100 °C. Work supported by the U. of Maryland NSF-MRSEC under Grant No. DMR 05-20741.

Mahito Yamamoto
Materials Research Science and Engineering Center,
University of Maryland, College Park

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